



# THE DATASHEET OF FSV530AF



# FSV530AF

## Schottky Barrier Rectifier

### Features

- Low Forward Voltage Drop: 0.54 V Maximum at 5 A,  $T_A = 25^\circ\text{C}$
- Ultra Thin Profile – Maximum Height of 1.0 mm
- High Surge Capacity
- UL Flammability 94V-0 Classification
- MSL 1
- Green Mold Compound
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

### Specifications

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

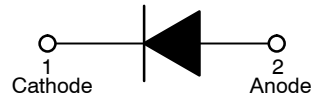
Symbol	Parameter	Value	Unit
$V_{RRM}$	Recurrent Peak Reverse Voltage	30	V
$V_{RMS}$	RMS Reverse Voltage	21	V
$V_R$	DC Blocking Voltage	30	V
$I_{F(AV)}$	Average Forward Current	5	A
$I_{FSM}$	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	100	A
$T_J$	Operating Junction Temperature Range	-55 to +150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to +150	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

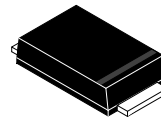


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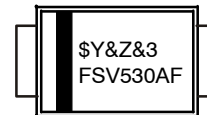


Schottky Barrier Rectifier



DO-214AD  
(SMAF)  
CASE 403AD

### MARKING DIAGRAM



Band Indicates Cathode

\$Y = ON Semiconductor Logo  
&Z = Assembly Plant Code  
&3 = Data Code (Year & Week)  
FSV530AF = Specific Device Code

### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

# FSV530AF

## THERMAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted) (Note 1)

Symbol	Characteristic	Value	Unit
$\Psi_{JL}$	Typical Thermal Characteristics, Junction-to-Lead (Note 2)	15	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient	120	$^\circ\text{C}/\text{W}$

1. Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
2. Thermocouple soldered at cathode lead.

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_F$	Forward Voltage	$I_F = 5\text{ A}$	-	-	0.54	V
$I_R$	Reverse Current	$V_R = 30\text{ V}$	-	-	100	$\mu\text{A}$
$T_{rr}$	Reverse Recovery Time	$I_F = 0.5\text{ A}$ , $I_R = 1\text{ A}$ , $I_{rr} = 0.25\text{ A}$	-	15.72	-	ns
$C_J$	Junction Capacitance	$V_R = 0\text{ V}$ , $f = 1\text{ MHz}$	-	159	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping†
FSV530AF	FSV530AF	DO-214AD (SMAF) (Pb-Free/Halogen Free)	10000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL PERFORMANCE CHARACTERISTICS

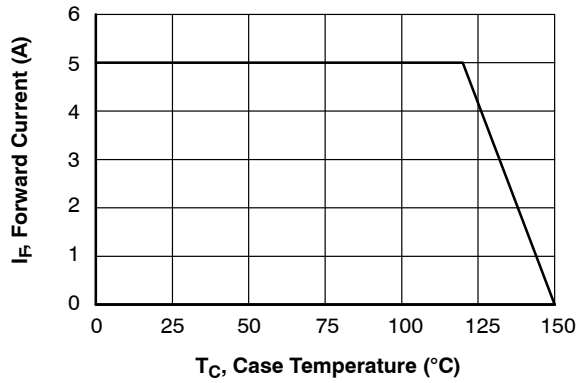


Figure 1. Forward Current Derating Curve

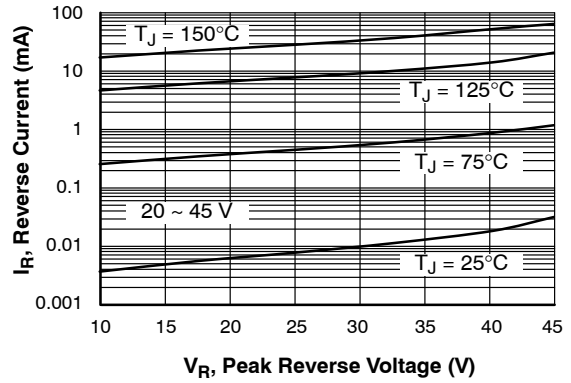


Figure 2. Typical Reverse Characteristics

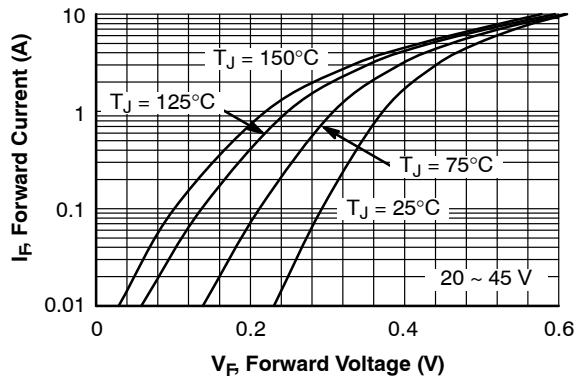


Figure 3. Typical Forward Characteristics

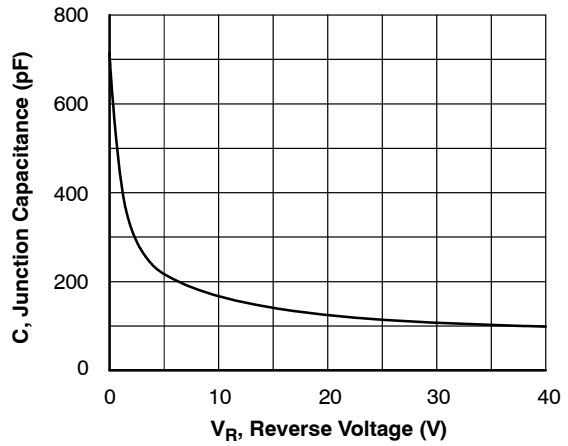
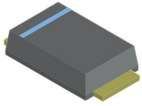


Figure 4. Typical Junction Capacitance

# MECHANICAL CASE OUTLINE

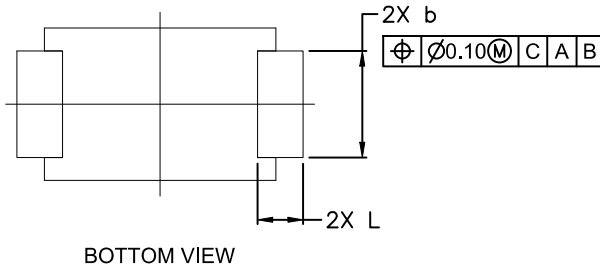
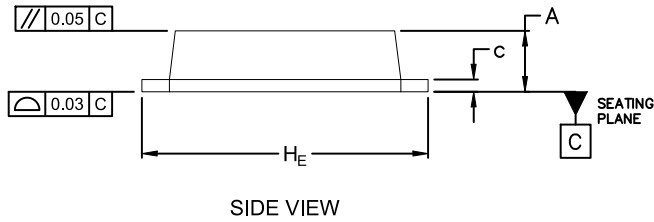
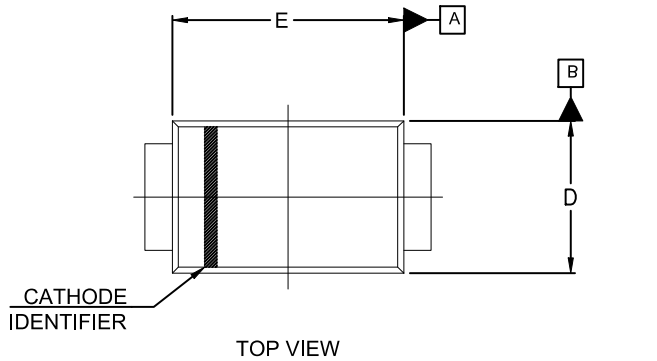
## PACKAGE DIMENSIONS

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### SMA-FL CASE 403AD ISSUE A

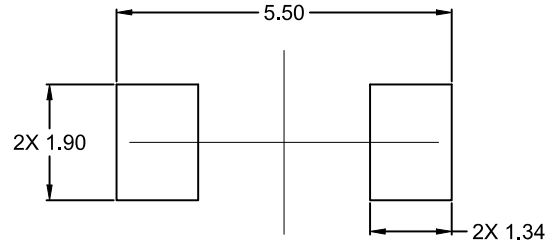
DATE 14 JUL 2020



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSIONS D & E ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
b	1.25	1.60	1.90
c	0.10	—	0.25
D	2.30	2.50	2.70
E	3.60	3.95	4.30
H <sub>E</sub>	4.40	4.80	5.20
L	0.50	0.75	0.95



RECOMMENDED  
MOUNTING FOOTPRINT\*

\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management